

CMOS BCD-to-Seven-Segment Latch/Decoder/Driver For Liquid-Crystal Displays

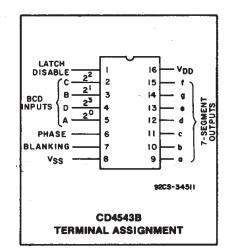
High-Voltage Types (20-Volt Rating)

Features:

- Display blanking of all illegal input combinations
- Latch storage of code
- Capability of driving two low power TTL loads, two HTL loads, or one low power Schottky load over the full rated-temperature range
- Pin-for-pin replacement for the CD4056B (with pin 7 tied to V_{SS})
- Direct LED driving capability

CD4543B is a BCD-to-seven segment latch/decoder/driver designed primarily for liquid-crystal display (LCD) applications. It is also capable of driving light emitting diode (LED), incandescent, gas-discharge, and fluorescent displays. This device is functionally similar to and serves as direct replacement for the CD4056B when pin 7 is connected to V_{SS} . It differs from the CD4056B in that it has a display blanking capability instead of a level-shifting function and requires only one power supply. When the CD4056B is used in the level shifting mode, two power supplies are required. When the CD4543B is used for LCD applications, a square wave must be applied to the PHASE input and the backplane of the LCD device. For LED applications a logic 0 is required at the PHASE input for common-cathode devices; a logic 1 is required for commonanode devices (see truth table).

The CD4543B is supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).



- 100% tested for guiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range)= 1 V at V_{DD}=5 V

- = 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

- Instrument display driver
- Dashboard display driver
- Computer/calculator display driver
- Timing device driver (clocks, watches, timers)

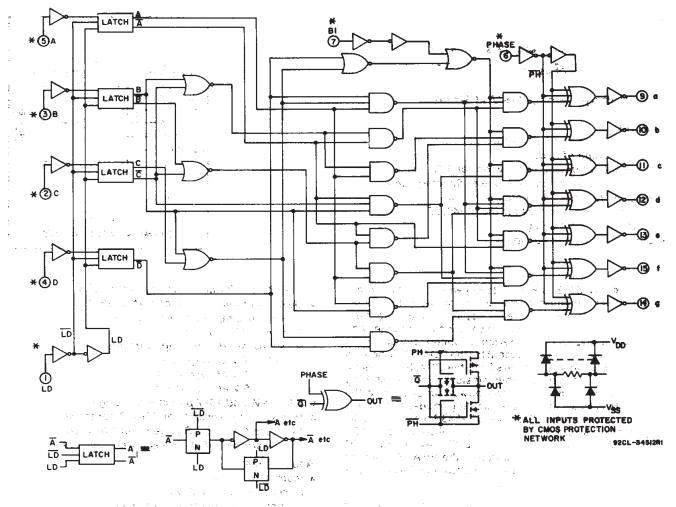


Fig. 1 - BCD-to-seven-segment latch/decoder/driver CD4543B logic circuit diagram.

RECOMMENDED OPERATING CONDITIONS at TA=25°C, Unless Otherwise Specified

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For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

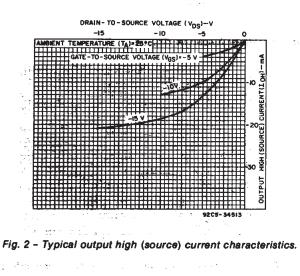
		Lik	14 - L		
CHARACTERISTIC	V _{DD}	MIN.	түр.	UNITS	
Supply-Voltage Range (For TA=Full Package-Temperature Range)		3	- 18	V	
	5	250	125	1	
Latch Disable Pulse Width twH	10	100	50	1. A.	
	15	80	40	1	
	5	60	15	t ·	
Minimum Data Setup Time tSU	10	20	-5	ns	
	15	10	-5		
	5	25	-5]	
Minimum Data Hold Time t _H	10	20	10		
	15	20	10		

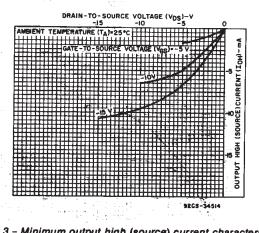
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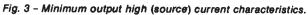
STATIC ELECTRICAL CHARACTERISTICS

CHARAC-	an an star Santa Santa Santa	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)								
TERISTIC		٧o	VIN	VDD			<u> </u>	1		+25		UNITS	
	1 	(V)	(V)	(V)	-55	-40	+85	+125	Min.	Тур.	Max.	1	
Quiescent			0, 5	5	5	5	150	150	—	0.04	5	i.	
Device	n me a terretaria da terretaria de la competitiva de la competitiv	621	0,10	10	10	10	300	300	—	0.04	10		
Current	IDD	land -	0,15	15	20	20	600	600	_	0.04	20	μA	
Max.		-	0,20	20	100	100	3000	3000	_	0.08	100		
Output Low (Sink)		0.4	0, 5	5	0.64	0.61	0.42	0.36	0.51	1	_		
Current	1	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	—		
Min.	IOL	1.5	0,15	. 15	4.2	4	2.8	2.4	3.4	6.8	-	mA 	
Output High		4.6	0, 5	. 5	-0.46	-0.44	-0.30	-0.26	-0.37	-0.75			
(Source)		, 2.5	0, 5	5	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—		
Current	IOH-	9.5	0,10	10	-0.98	-0.92	-0.68	-0.55	-0.8	-1.6	—		
Min.		13.5	0,15	15	-3.33	-3.18	-2.2	-1.9	-2.7	-5.4			
Output Voltage:	n National and a	-	0, 5	5	e ·	0.	05		—	0	0.05		
Low-Level	VOL		0,10	10		0.	05		—	0	0.05		
Max.			0,15	_15		0.	05		—	0	0.05	v	
Output Voltage:		. —	0, 5	5		4.9	95		4.95	5		. •	
High-Level	Voh	<u> </u>	0,10	. 10	14.5	9.	95	8) -	9.95	10		i den i i Li den i i	
Min.		_	0,15	15		14.	95		14.95	15	_		
Input Low		0.5,4.5		5		1.	5			-	1.5		
Voltage	VIL	1, 9	ä. —	10		3	3				3		
Max.		1.5,13.5	<u></u>	15		4	<u>L</u>		—	_	4		
Input High		0.5,4.5	. —	5		3.	5	2	3.5	_	—	V	
Voltage	∨ін	1, 9		10		7		*	7		—		
Min.		1.5,13.5	-	15		1	1		11	_	—		
Input Current Max.	NI	_	0,18	18	±0.1	±0.1	±1	±1	د	±10 ⁻⁵	±0.1	μA	

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A Second Second

DYNAMIC ELECTRICAL	CHARACTERISTICS	at TA=25° C:	Ci =50 pF	. Input tr.tr=20 ns. R	i =200 kΩ
				i	

CHARACTERISTIC		TEST CONDITIONS		LIMITS All Packages		
		V _{DD} (V)	MIN.	TYP.	MAX.	
Propagation Delay Time	^t PHL	5	-	600	1200	
		10	-	200	400	
		15		150	300	
		5	—	500	1000	
	^t PLH	10	-	200	400	
· ·		15		150	300	
		5		180	360	
Transition Time	THL	10	<u> </u>	90	180	
• •	· · ·	15	·	65	130	
		5		180	360	ns
	^t TLH	10	—	90	180	
		15		65	130	
		5	250	125	-	
Latch Disable Pulse Width	tWH	10	100	50	-	
		15	80	40	—	
		5	60	15	-	
Address Setup Time	tSU	10	20	-5		
		15	10	-5	_	
		5	25	-5	-	
Address Hold Time	tн	10	20	10	-	
· · · · · · · · · · · · · · · · · · ·		15	20	10		
Input Capacitance	CIN	Any Input	-	5	7.5	pF
				L		

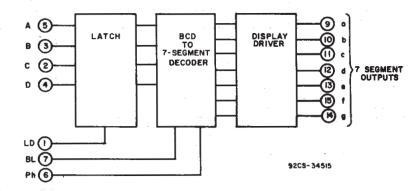
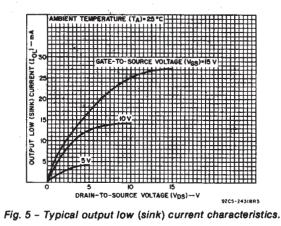
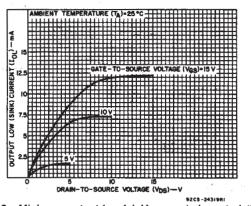
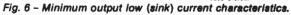


Fig. 4 - BCD-to-seven-segment latch/decoder/driver functional diagram.

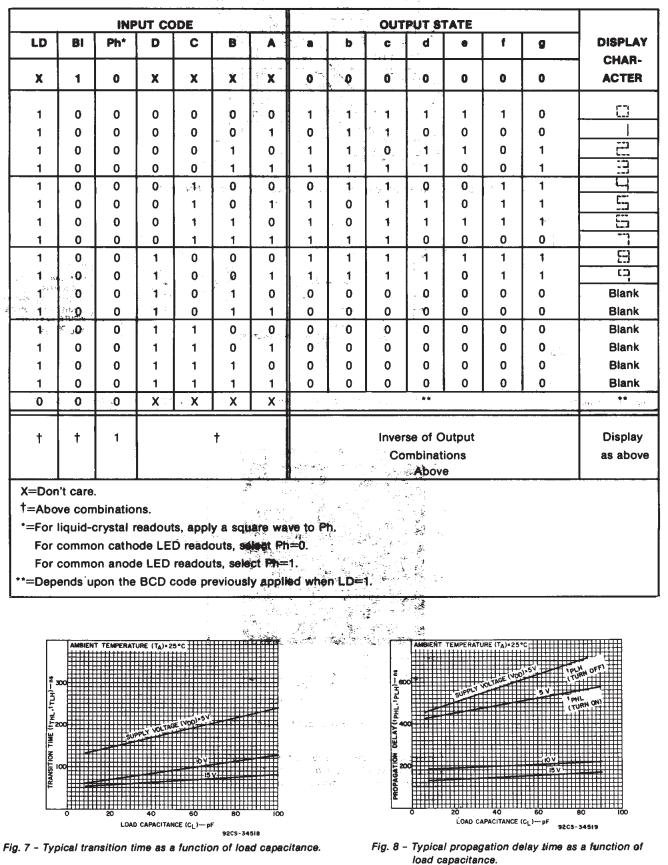






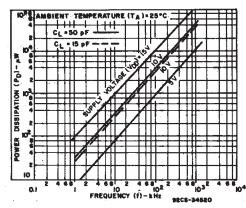
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14	- FRITE	FAMIP	P13R	CD4543B



COMMERCIAL CMOS HIGH VOLTAGE ICs

3-333





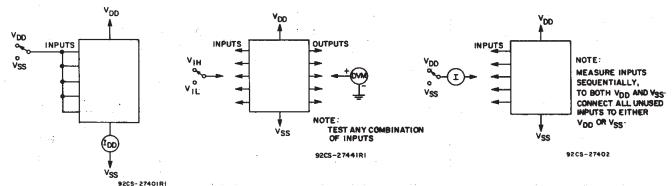
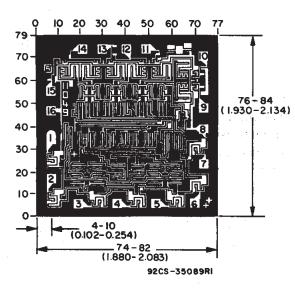


Fig. 12 - Input current test circuit.

Fig. 11 - Input voltage test circuit.

Fig. 10 – Quiescent device current test circuit.



Dimensions and pad layout for CD4543BH.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch). TEXAS INSTRUMENTS

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CD4543BE	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4543BM	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BM96	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BM96E4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BME4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BMT	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BMTE4	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BNSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BNSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BPWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4543BPWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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